

APRIL 23 - 26, 2023, SAN ANTONIO, TX USA

https://ieee-cicc.org

The IEEE Custom Integrated Circuits Conference (CICC) is a premier conference devoted to Integrated Circuit research & development. 2023 will be the 34rd year of operation, showcasing original, first-published innovative work on analog & digital circuit & system techniques covering a broad spectrum of technical topics.

CICC is a forum for analog mixed-signal IC and SoC designers, CAD developers, IC foundries and manufacturers, technology providers and ASIC users. The CICC community is growing and in 2021 we had a record-breaking virtual attendance of over 530 industry professionals, faculty and students from all regions in the world. 2022 was a hybrid event, with 342 registrants. We are moving back to normal in person participation in 2023.

CICC features a technical program with over 130 lecture presentations and 16 educational presentations that will bring professionals up to speed with recent advances in IC state-of-the-art. The conference also includes forums and panel discussions, for peers to interact with each other.

Our sponsors are a fundamental part of CICC. They make the conference possible, help top students attend, promote education and cooperation, and contribute directly to the long-term future of our industry.

The sponsorship program gets your company's name in front of the most influential people from industry and academia. By supporting this foremost IC design conference, you demonstrate great leadership and community involvement. This brochure highlights some of the available options.

If you are interested in becoming a sponsor, please contact the CICC 2023 Sponsorship Chair, Shenggao Li, at victorli@tsmc.com or Co-Chair, Alicia Klinefelter, at aklinefelter@nvidia.com;

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¹ (Rev2023-1-27)

Sponsorship Opportunities

CICC provides a range of opportunities for companies to show their commitment to the technical and scientific community. Sponsors are individually recognized by name in a variety of ways.

Sponsorship Levels and Benefits:

4 levels of sponsorships are available.

Amont	Sponsorship Level	Publicity and brand recognition on CICC publications & <u>www.ieee-cicc.org</u>	Recognized in specific sponsored events
>\$15,000	Platinum	Sponsor company Logo and Name shown as Platinum Sponsor	Company Name and Logo will be shown exclusively in specific events selected by sponsors. For example, if a sponsor funds a keynote speech event, the sponsor company Logo/Name will be displayed to all participants.
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>\$3,000	Bronze	Sponsor company Logo and Name shown as Bronze Sponsor	

Specific Sponsorship Events

Events	Opportunities (note1)	Amounts/each
General Conference	1	\$15,000
Keynote Speeches	2	\$5,000
Keynote Lunch	1	\$5,000
Education Sessions	4 (note2)	\$5,000
Forum Sessions	4	\$2,500
Technical Sessions	13 long 16 short (note3)	long \$2,500, short \$1,500
Overall outstanding Paper Awards	1	\$7,500
Outstanding Paper Awards	4	\$5,000

note1: A sponsor company may request to sponsor one or more specific sessions, for example, ADCs or wireline IOs, on a first come first serve basis, or sponsor those more prestigious events such as a keynote speech by an invited speaker.

note2: An education session typically lasts for a day with multiple speakers giving tutorials.

note3: A long/short technical session typically lasts for 3.5/2 hours respectively, with 6-8 presentations.

2023 CICC CICC Technical Sessions	Subcommittee	Short/Long Session
Analog Techniques	Analog	Short
Analog Sensor Interfaces	Analog	Long
Timing Circuits	Analog	Long
Gigasample-Rate Data Converters	Data Converters	Long
ADCs with Noise Shaping	Data Converters	Long
Data Converter Design Techniques	Data Converters	Long
Low-power Digital Circuits	Digital Circuits	Short
Hardware Security	Digital Circuits	Short
Machine Learning	Digital Circuits	Long
Compute in Memory and Ising Machines	Digital Circuits	Long
Architectures for advancing computing	Emerging Tech	Short
Advances in low-power, high-performance sensor interfaces	Emerging Tech	Long
Heterogenous SoCs for Next-Gen Compute Applications	Foundations	Long
Mixed-Signal Foundational IPs for Emerging Systems	Foundations	Long
Gate Drivers and GaN ICs	Power Management	Short
Energy Harvesting and Wireless/Isolated Power Converters	Power Management	Short
DC-DC Converters	Power Management	Long
Low Power Quantum Computing & Wireless Transceivers	Wireless	Short
mm-Wave Transceiver and Front-end Building Blocks for Radar and Communication	Wireless	Short
Frequency generation, clocking and power transfer	Wireless	Long
Recent advances in Silicon based Terahertz solutions	Wireless	Long
Advanced Techniques for Wireline Communications	Wireline	Short
Where is the balance between circuit and system-level innovation in our solid-state circuit conference?	Panel - Analog	Short
It's 2023. Where are our self-driving cars?	Panel - Wireless	Short
Improving ASIC Productivity	Panel - Digital	Short
CHIPS Act and Future of Semiconductor Innovation	Panel - Wireline	Short
100+ GS/s Data Converters	Forum	Short
Recent Progress in LDOs and Voltage, Current, and Timing References	Forum	Short
Standardizing Chiplet Design	Forum	Short
Emerging Electrical and Optical Devices for Biomedical Applications	Forum	Short

CICC 2023 Sponsorship Acknowledgement (As of 1/26/2023)

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CICC 2022 Sponsorship Acknowledgement

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